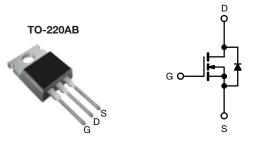
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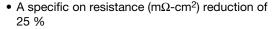
# **EF Series Power MOSFET With Fast Body Diode**



N_Channal	MOSEET

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	0.084		
Q <sub>g</sub> max. (nC)	134			
Q <sub>gs</sub> (nC)	16			
Q <sub>gd</sub> (nC)	48			
Configuration	Single			

#### **FEATURES**





- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (C<sub>iss</sub>)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qq)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP35N60EF-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	600	V	
Gate-source voltage			$V_{GS}$	± 30	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I <sub>D</sub>	32	A	
		T <sub>C</sub> = 100 °C		20		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	80	I	
Linear derating factor				2.0	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	298	mJ	
Maximum power dissipation			P <sub>D</sub>	250	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C		dv/dt	100	V/ns	
Reverse diode dv/dt <sup>d</sup>	erse diode dv/dt d			50	V/IIS	
Soldering recommendations (peak temperature) c	For 10 s			260	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 4.6 A
- c. 1.6 mm from case
- d.  $I_{SD} = 17 \text{ A}$ ,  $di/dt = 300 \text{ A/}\mu\text{s}$ , starting  $T_J = 25 \,^{\circ}\text{C}$



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum junction-to-case (drain)	$R_{thJC}$	-	0.5	G/ <b>V</b> V	

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 10 mA		0.66	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		-	4.0	V
Cata assuma laglanda		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μΑ
Zava sata valtasa duain ayuwant		$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	500	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 17 A	-	0.084	0.097	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 17 A		8	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	2568	-	pF
Output capacitance	C <sub>oss</sub>	,	$V_{DS} = 100 \text{ V},$		113	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	7	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	81	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	421	-	
Total gate charge	Qg		V <sub>GS</sub> = 10 V I <sub>D</sub> = 17 A, V <sub>DS</sub> = 480 V		89	134	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V			16	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	48	-	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 17 A,		-	28	56	
Rise time	t <sub>r</sub>			-	85	170	
Turn-off delay time	t <sub>d(off)</sub>		$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		96	192	ns
Fall time	t <sub>f</sub>	1		-	61	122	
Gate input resistance	$R_g$	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	32	
Pulsed diode forward current	I <sub>SM</sub>			-	-	80	Α
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 17 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	-		-	150	300	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}$ , $I_F = I_S = 17 \text{A}$ , $\text{di/dt} = 100 \text{A/\mu s}$ , $V_R = 400 \text{V}$		-	1.1	2.2	μC
Reverse recovery current	I <sub>RRM</sub>			_	14	-	Α

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

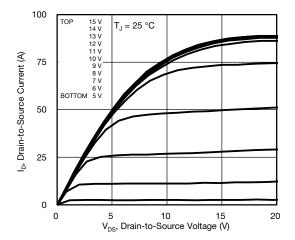


Fig. 1 - Typical Output Characteristics

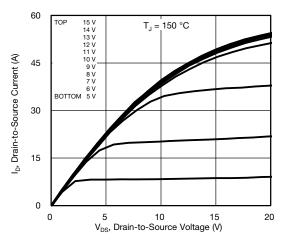


Fig. 2 - Typical Output Characteristics

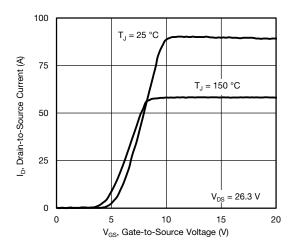


Fig. 3 - Typical Transfer Characteristics

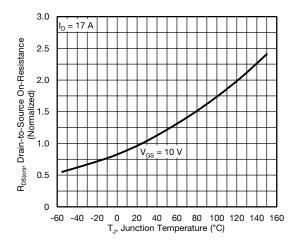


Fig. 4 - Normalized On-Resistance vs. Temperature

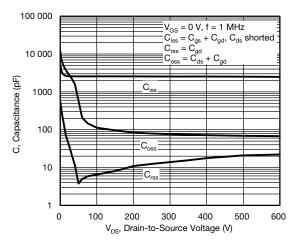


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

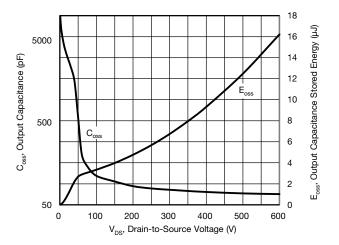


Fig. 6 - Coss and Eoss vs. VDS



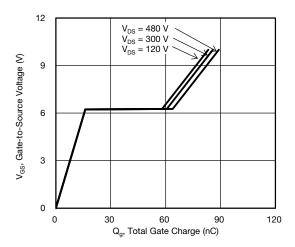


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

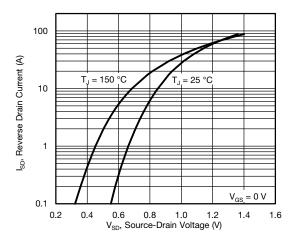


Fig. 8 - Typical Source-Drain Diode Forward Voltage

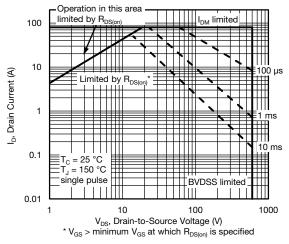


Fig. 9 - Maximum Safe Operating Area

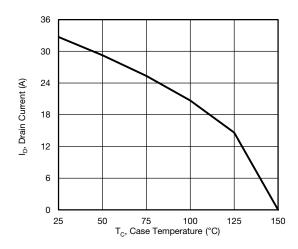


Fig. 10 - Maximum Drain Current vs. Case Temperature

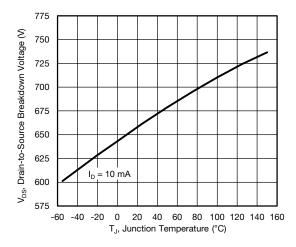


Fig. 11 - Temperature vs. Drain-to-Source Voltage



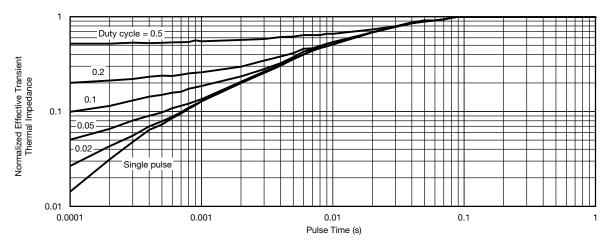


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

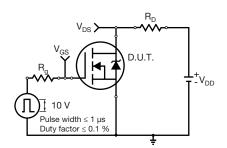


Fig. 13 - Switching Time Test Circuit

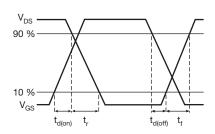


Fig. 14 - Switching Time Waveforms

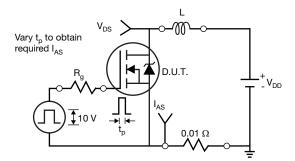


Fig. 15 - Unclamped Inductive Test Circuit

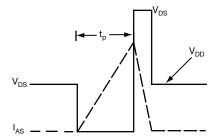


Fig. 16 - Unclamped Inductive Waveforms

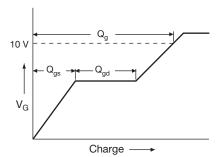


Fig. 17 - Basic Gate Charge Waveform

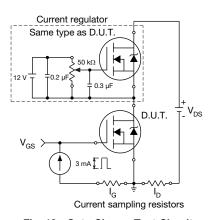
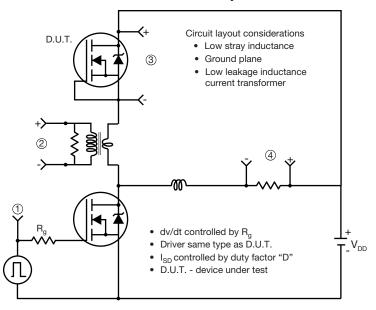


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dv/dt Test Circuit



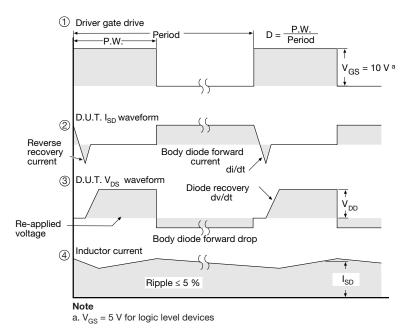


Fig. 19 - For N-Channel

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## SiHP35N60EF



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Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?92107">www.vishay.com/ppg?92107</a>.



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